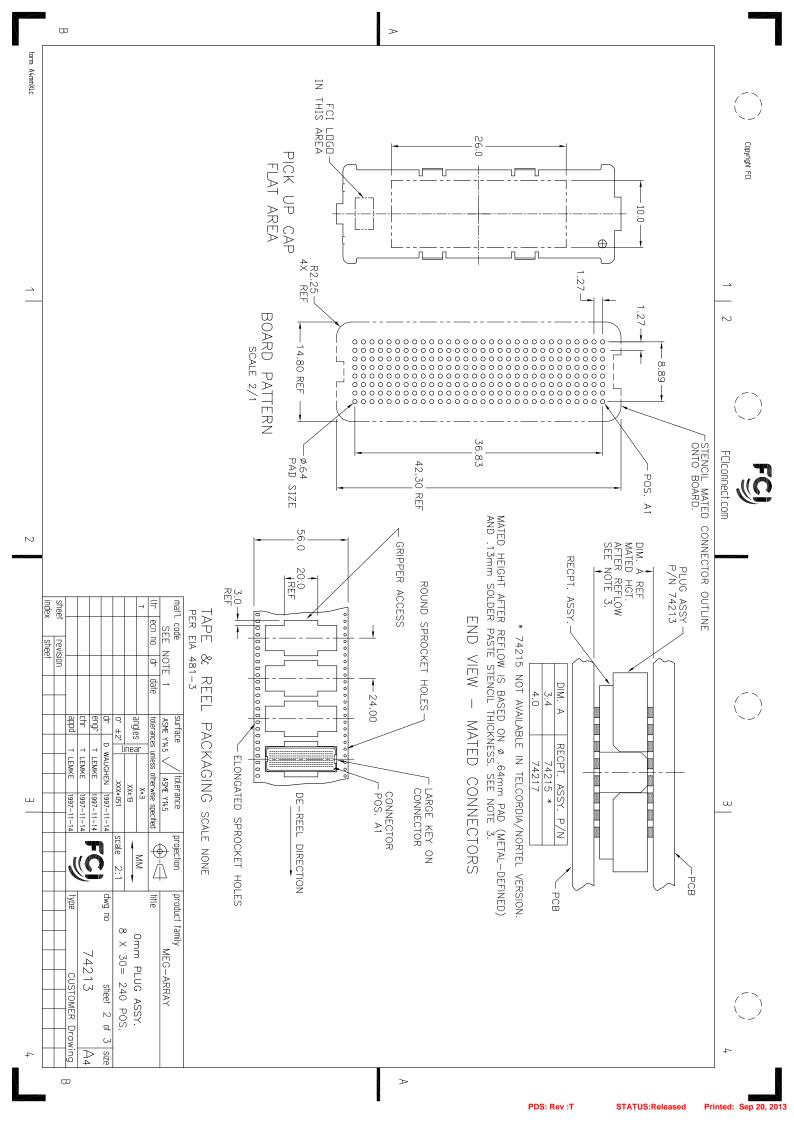


PDS: Rev :T

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1.) <u>MAT'L:</u>

NOTES:

HOUSING: LCP, FLAME RETARDANT PER UL 94V-0 CONTACT: COPPER ALLOY

<u>PLATING</u> SOLDER BALL: (SEE TABLE ON THIS SHEET) EUTECTIC SnPb OR LEAD FREE 95.5Sn/4Ag/0.5Cu CONTACT: (SEE TABLE ON THIS SHEET)

2.) SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.

(3.)MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE.

(4.)PLATING FOR INDICATED -2XX SERIES PRODUCT NUMBERS MEET THE REQUIREMENTS OF GR-1217-CORE, CONTACT GEOMETRY IN THESE PRODUCT NUMBERS IS SPECIAL, ALSO CENTRAL OFFICE ENVIRONMENT, (25 YEAR LIFE EXPECTANCY). THE

(5) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION

(ō) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION

(7) 74213-302, -302LF, -402, -402LF, -502 AND ARE OBSOLETE PRODUCT NUMBERS. -502LF

74213-502LF	74213-502	74213-402LF	74213-402	74213 302LF	74213 302	74213-292LF	74213-292	74213-202LF	74213-202	74213-192LF	74213-192	74213-102LF	74213-102	74213-092LF	74213-092	74213-002LF	74213-002	PRODUCT NUMBER
YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES	PICK-UP CAP NATURAL OR BLACK COLOR
Au SPECIAL	Au SPECIAL	30u" (.76um) Au SPECIAL	30u" (.76um) Au SPECIAL	15u" (.38um) Au SPECIAL	15u" (.38um) Au SPECIAL	50u" (1.27um) GXT SPECIAL	50u" (1.27um) GXT SPECIAL	50u" (1.27um) Au SPECIAL	50u" (1.27um) Au SPECIAL	30u" (.76um) GXT	30u" (.76um) GXT	30u" (.76um) Au	30u" (.76um) Au	15u" (.38um) GXT	15u" (.38um) GXT	15u" (.38um) Au	15u" (.38um) Au	CONTACT PLATING AND THICKNESS
LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	LEAD FREE	SnPb	SOLDER BALL
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